

Vishay General Semiconductor

# **Glass Passivated Ultrafast Rectifier**



### **FEATURES**

- · Superectifier structure for high reliability condition
- · Cavity-free glass-passivated junction
- · Ultrafast reverse recovery time
- · Low forward voltage drop
- · Low leakage current
- · Low switching losses, high efficiency
- High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- AEC-Q101 qualified
- · Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

### **TYPICAL APPLICATIONS**

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

### **MECHANICAL DATA**

Case: GP20, molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade Base P/NHE3 - RoHS compliant, AEC-Q101 gualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	EGP30A	EGP30B	EGP30C	EGP30D	EGP30F	EGP30G	UNIT	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	150	200	300	400	V	
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	210	280	V	
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	150	200	300	400	V	
Maximum average forward rectified current 0.375" (9.5 mm) lead length at $T_A = 55$ °C	I <sub>F(AV)</sub> 3.0							А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	vi 125						А	
Operating and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	J, T <sub>STG</sub> - 65 to + 150						°C	

Document Number: 88584 For technical questions within your region, please contact one of the following: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com

#### **PRIMARY CHARACTERISTICS** 3.0 A I<sub>F(AV)</sub> 50 V to 400 V $V_{RRM}$ 125 A I<sub>FSM</sub> 50 ns t<sub>rr</sub> 0.95 V, 1.25 V $V_{F}$ 150 °C T<sub>J</sub> max.



Revision: 15-Mar-11



RoHS COMPLIANT

# Vishay General Semiconductor



<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	EGP30A	EGP30B	EGP30C	EGP30D	EGP30F	EGP30G	UNIT
Maximum instantaneous forward voltage	3.0 A		V <sub>F</sub>	0.95			1.25		v	
Maximum DC		T <sub>A</sub> = 25 °C		5.0					_	
reverse current at rated DC blocking voltage		T <sub>A</sub> = 125 °C	IR	100						μA
Maximum reverse recovery time	$I_{\rm F} = 0.5$ A, $I_{\rm R} = 1.0$ A, $I_{\rm rr} = 0.25$ A		t <sub>rr</sub>	50					ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	85			7	5	pF	

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)									
PARAMETER	SYMBOL	EGP30A	EGP30B	EGP30C	EGP30D	EGP30F	EGP30G	UNIT	
	R <sub>0JA</sub> <sup>(1)</sup>	20						°C/W	
Typical thermal resistance	$R_{\theta JL}$ <sup>(1)</sup>	8.0						C/ W	

#### Note

<sup>(1)</sup> Thermal resistance from junction to ambient, and from junction to lead at 0.375" (9.5 mm) lead length, PCB mounted

ORDERING INFORMATION (Example)									
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE					
EGP30G-E3/54	1.01	54	1400	13" diameter paper tape and reel					
EGP30G-E3/73	1.01	73	1000	Ammo pack packaging					
EGP30GHE3/54 (1)	1.01	54	1400	13" diameter paper tape and reel					
EGP30GHE3/73 <sup>(1)</sup>	1.01	73	1000	Ammo pack packaging					

#### Note

(1) AEC-Q101 qualified

### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

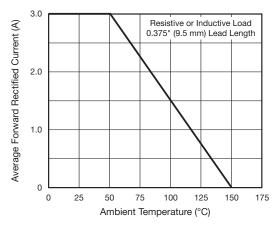


Fig. 1 - Maximum Forward Current Derating Curve

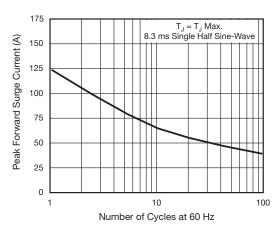


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

For technical questions within your region, please contact one of the following: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com

Document Number: 88584 Revision: 15-Mar-11

This datasheet is subject to change without notice. THE PRODUCT DESCRIBED HEREIN AND THIS DATASHEET ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



# EGP30A thru EGP30G

# Vishay General Semiconductor

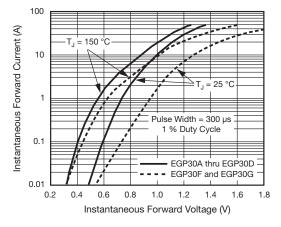


Fig. 3 - Typical Instantaneous Forward Characteristics

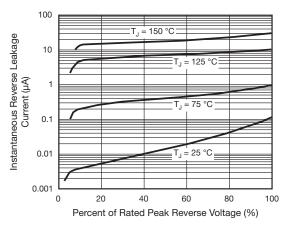


Fig. 4 - Typical Reverse Leakage Characteristics

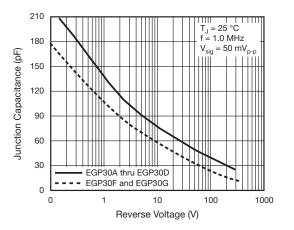


Fig. 5 - Typical Junction Capacitance

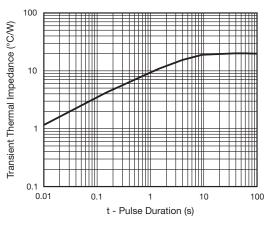
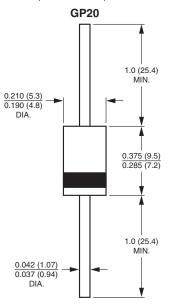


Fig. 6 - Typical Transient Thermal Impedance

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



 Document Number:
 88584
 For technical questions within your region, please contact one of the following:
 www

 Revision:
 15-Mar-11
 DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com
 Www

www.vishay.com 3

This datasheet is subject to change without notice. THE PRODUCT DESCRIBED HEREIN AND THIS DATASHEET ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay

# Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.